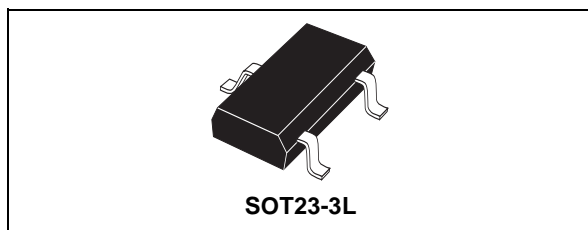


## Automotive dual-line Transil™, transient voltage suppressor (TVS) for CAN bus

Datasheet - production data



### Features

- Dual-line ESD and EOS protection
- Bidirectional device
- Max pulse power: 230 W (8/20 μs)
- Stand-off voltage 24 V
- Low clamping factor  $V_{CL} / V_{BR}$
- Fast response time
- Low leakage current
- Small plastic package
- ECOPACK®2 compliant component
- AEC-Q101 qualified

### Benefits

- ESD and EOS protection for CAN transceiver
- SOT23 package for space saving on high density printed circuit board
- Transil diodes providing high overvoltage protection by clamping action and instantaneous response to transient overvoltage

### Complies with the following standards

- ISO 10605 - C = 150 pF, R = 330 Ω :
  - 30 kV (air discharge)
  - 30 kV (contact discharge)
- ISO 10605 - C = 330 pF, R = 330 Ω :
  - 30 kV (air discharge)
  - 30 kV (contact discharge)
- ISO 7637-3:
  - Pulse 3a:  $V_s = -150$  V
  - Pulse 3b:  $V_s = +100$  V

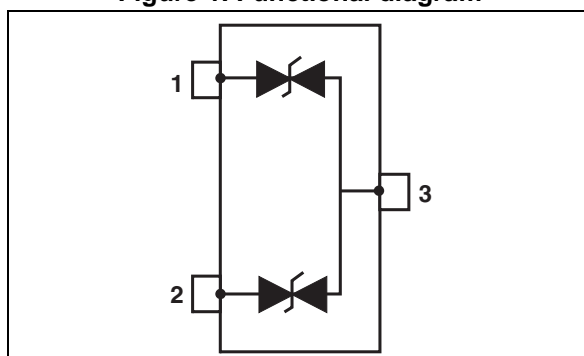
### Application

Automotive controller area network (CAN) bus lines where electrostatic discharge and other transients must be suppressed.

### Description

The ESDCAN01-2BLY is a dual-line Transil specifically designed for the protection of the automotive CAN bus lines against electrostatic discharge (ESD).

Figure 1. Functional diagram



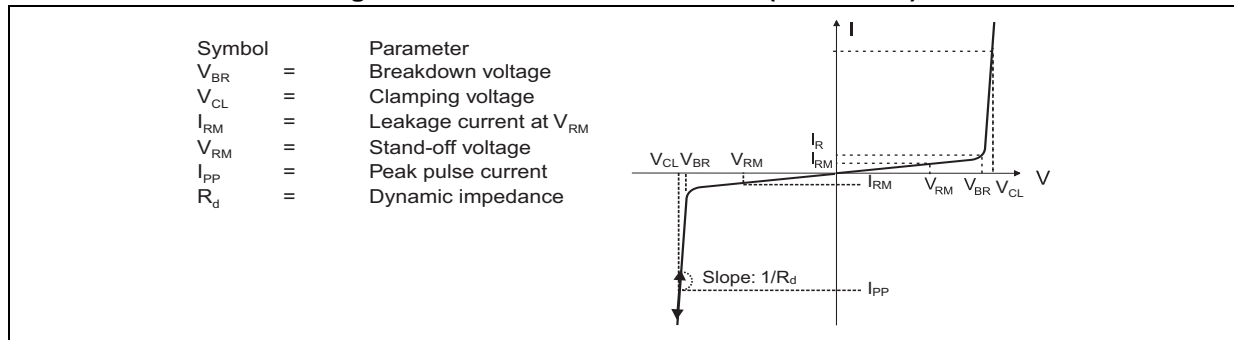
TM: Transil is a trademark of STMicroelectronics

# 1 Characteristics

**Table 1. Absolute maximum ratings ( $T_{amb} = 25^{\circ}\text{C}$ )**

Symbol	Parameter		Value	Unit
$V_{PP}$	Electrostatic discharge capability	ISO 10605 - C = 150 pF, R = 330 $\Omega$ :		kV
		Contact discharge	30	
		Air discharge	30	
		ISO 10605 - C = 330 pF, R = 330 $\Omega$ :		
		Contact discharge	30	
		Air discharge	30	
		HBM MIL STD 883	8	
$P_{PP}$	Peak pulse power dissipation (8/20 $\mu\text{s}$ )	$T_j \text{ initial} = T_{amb}$	230	W
$I_{PP}$	Peak pulse current (8/20 $\mu\text{s}$ )		5.5	A
$T_{op}$	Operating junction temperature range		-55 to +150	$^{\circ}\text{C}$
$T_{stg}$	Storage temperature range		-55 to +150	$^{\circ}\text{C}$

**Figure 2. Electrical characteristics (definitions)**



**Table 2. Electrical characteristics (values,  $T_{amb} = 25^{\circ}\text{C}$ )**

Symbol	Test conditions	Min.	Typ.	Max.	Unit
$V_{RM}$	Stand-off voltage			24	V
$V_{BR}$	$I_R = 1 \text{ mA}$	25		30	V
$I_{RM}$	$V_{RM} = 24 \text{ V}$			100	nA
$V_{CL}$	Pulse ISO 7637-3 Pulse 3b			35	V
$V_{CL}$	Pulse ISO 7637-3 Pulse 3a	-35			V
$V_{CL}$	$I_{PP} = 5 \text{ A}, 8/20\mu\text{s}$			40	V
$\alpha T^{(1)}$	Voltage temperature coefficient			9	$10^{-4}/^{\circ}\text{C}$
C	$V_R = 0 \text{ V DC}, F = 1 \text{ MHz}$			30	pF

1.  $\Delta V_{BR} = \alpha \times T \times (T_{amb} - 25) \times V_{BR}(25^{\circ}\text{C})$

Figure 3. Peak pulse power versus initial junction temperature (maximum values)

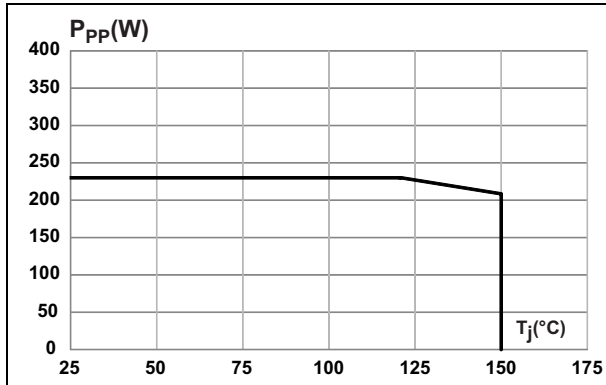


Figure 4. Junction capacitance versus reverse voltage applied (typical values)

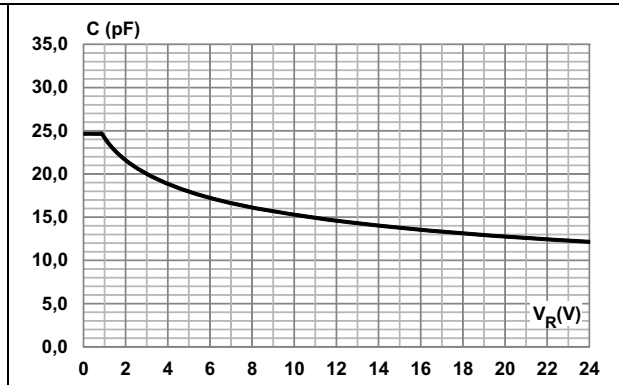


Figure 5. Peak pulse power versus exponential pulse (maximum values)

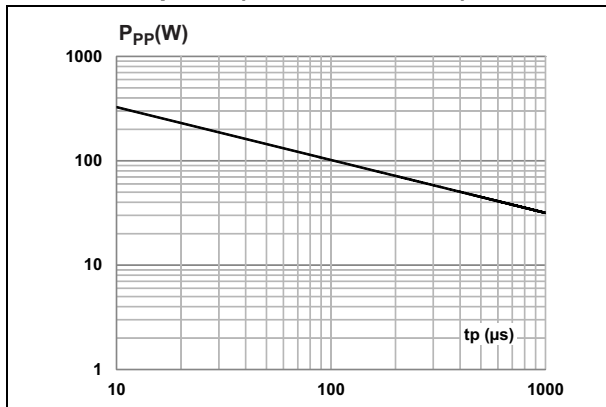


Figure 6. Clamping voltage versus peak pulse current (typical values)

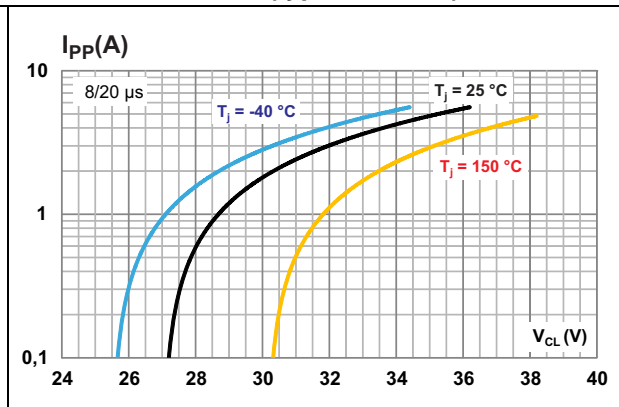


Figure 7. Leakage current versus junction temperature (typical values)

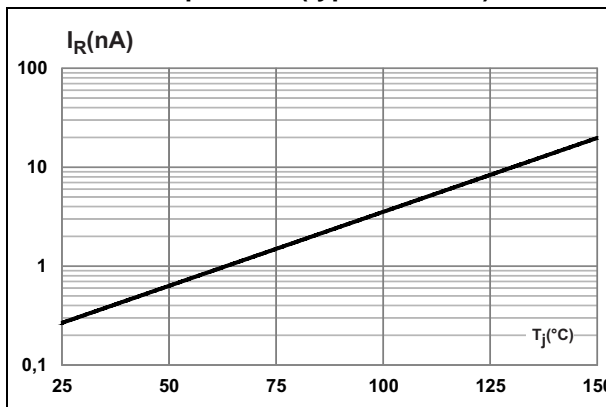


Figure 8. S21 attenuation

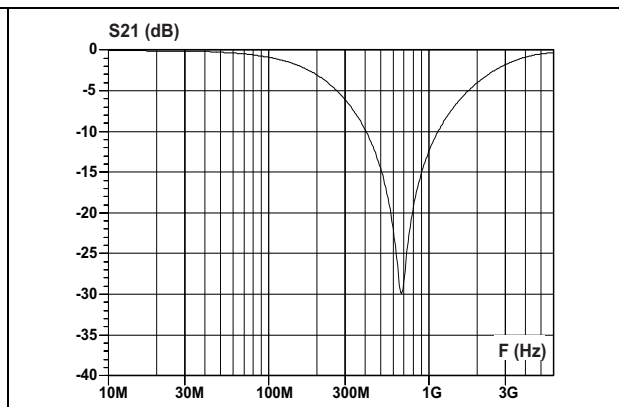


Figure 9. ESD response to ISO 10605 -  
C = 150 pF, R = 330 Ω (+8 kV contact)

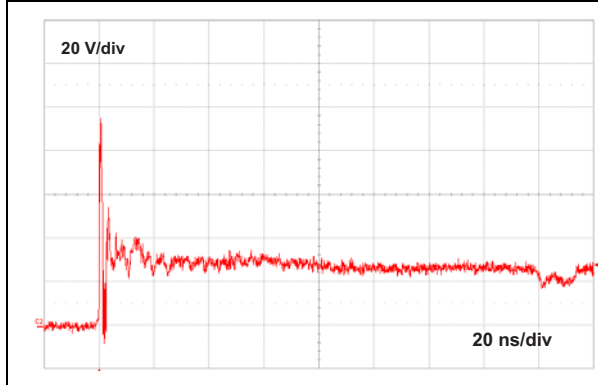


Figure 10. ESD response to ISO 10605 -  
C = 150 pF, R = 330 Ω (-8 kV contact)

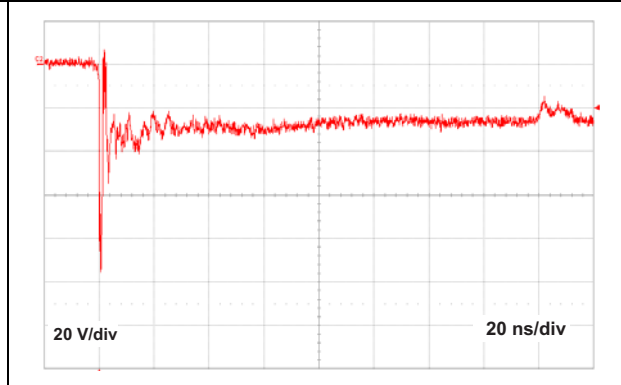


Figure 11. Response to ISO 7637-3 Pulse 3a  
(Us = -150 V)

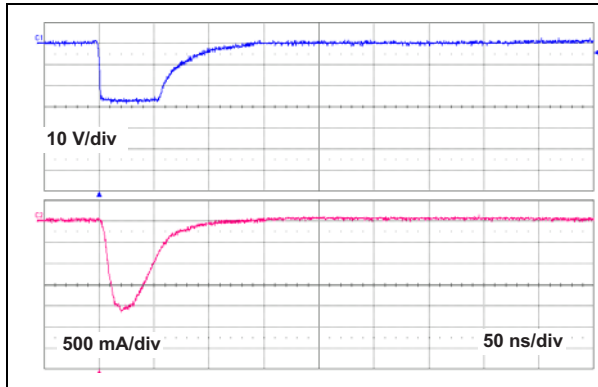


Figure 12. Response to ISO 7637-3 Pulse 3b  
(Us = +100 V)

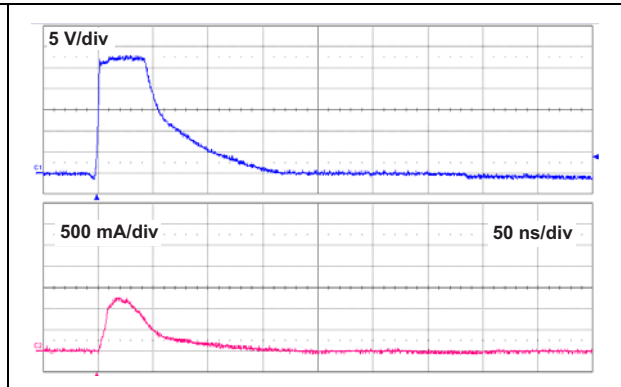
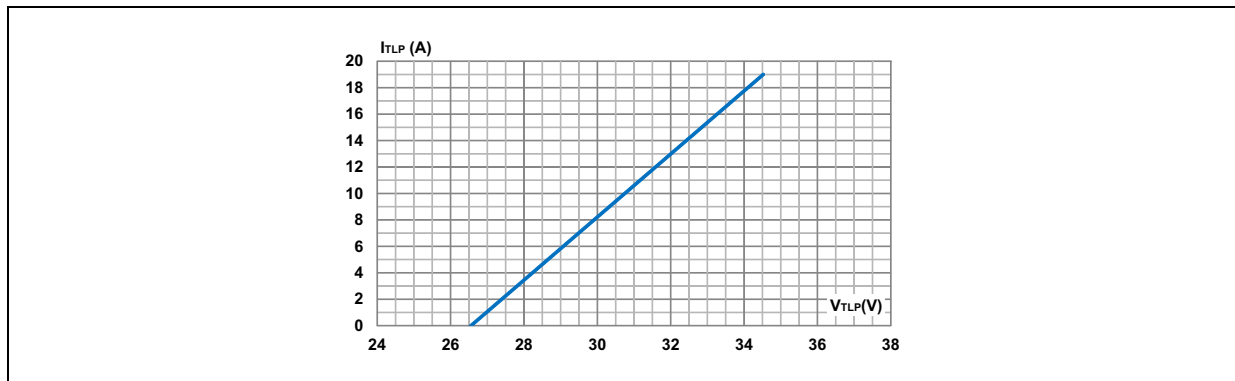


Figure 13. TLP measurements



## 2 Application and design guidelines

More information is available in the ST Application note AN2689 “Protection of automotive electronics from electrical hazards, guidelines for design and component selection”.

### 3 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

Figure 14. SOT23-3L dimension definitions

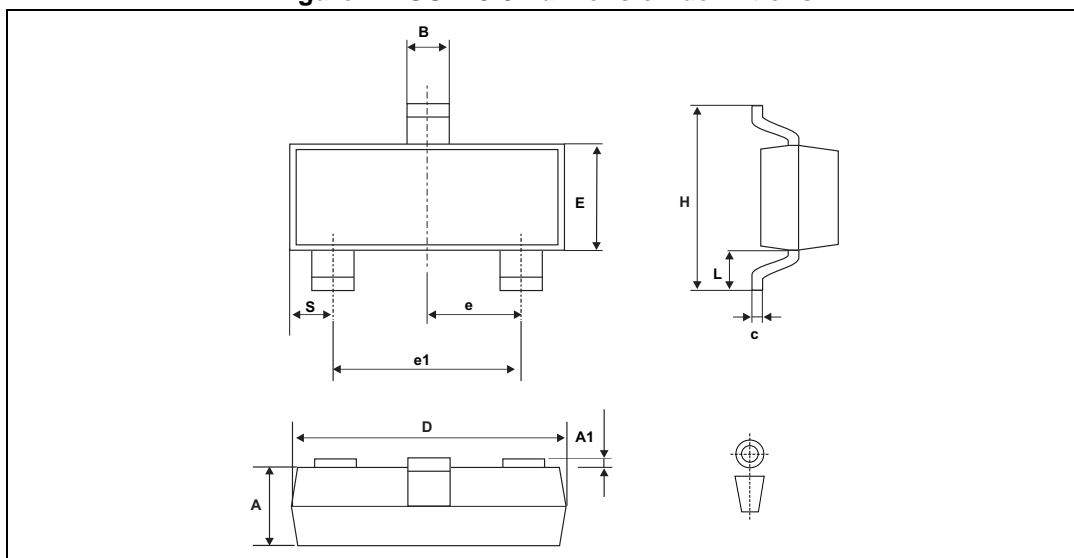
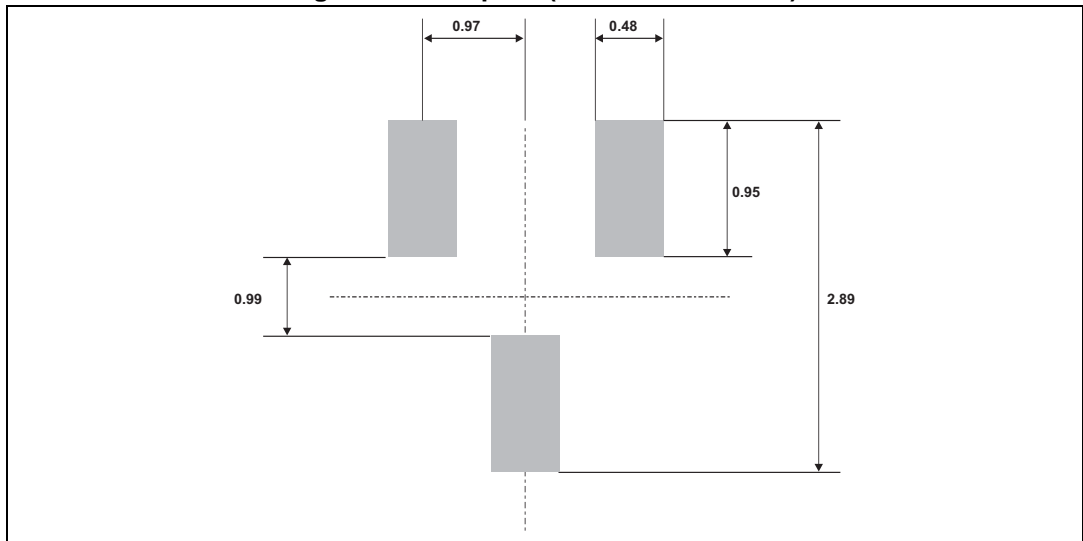


Table 3. SOT23-3L dimension values

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.89	1.4	0.035	0.055
A1	0	0.1	0	0.004
B	0.3	0.51	0.012	0.02
C	0.085	0.18	0.003	0.007
D	2.75	3.04	0.108	0.12
e	0.85	1.05	0.033	0.041
e1	1.7	2.1	0.067	0.083
E	1.2	1.75	0.047	0.069
H	2.1	3.00	0.083	0.118
L	0.6 typ.		0.024 typ.	
S	0.35	0.65	0.013	0.026

Figure 15. Footprint (dimensions in mm)



## 4 Ordering information

Figure 16. Ordering information scheme

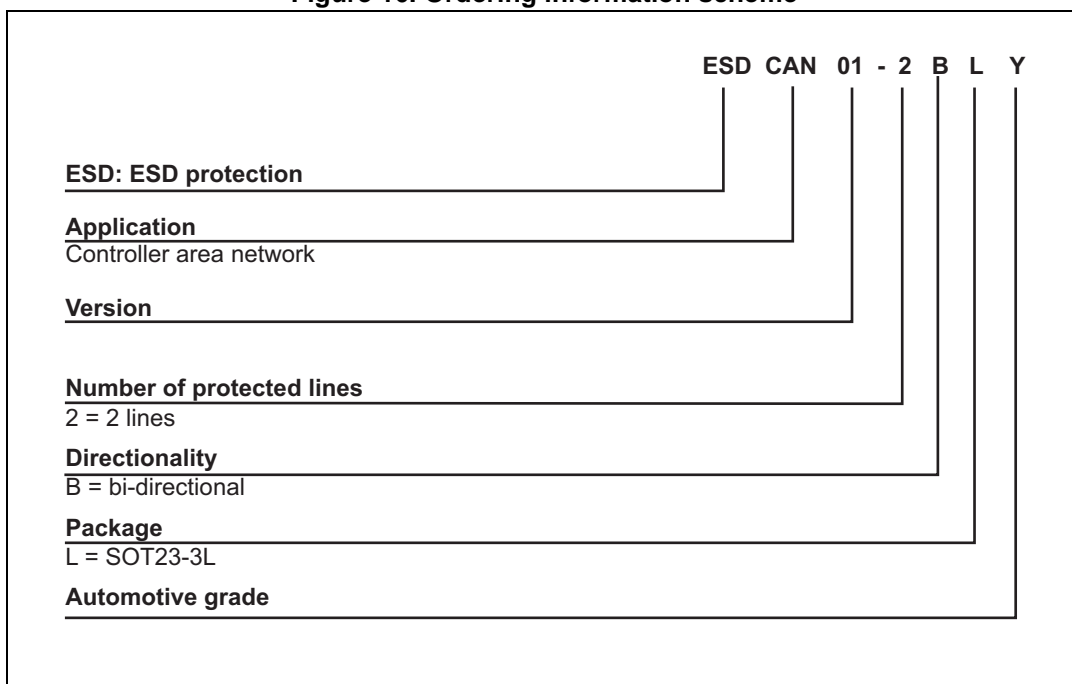


Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ESDCAN01-2BLY	EN24	SOT-23	9.7 mg	3000	Tape and reel

## 5 Revision history

Table 5. Document revision history

Date	Revision	Changes
23-Jun-2014	1	First issue.

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